

FEB 13 2002 6:11 PM FR LGL DEPT

7323213102 TO 919727329218

P.02

FORM PTO-1595

(Rev. 6-93)

OMB No. 0651-0011 (exp. 4/94)

03-05-2002



To the Honorable Commi

1. Name of conveying party(ies):

Helmut H. Tews
Ravikumar Ramachandran
Kil-Ho Lee

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other _____

Execution Date: February 8, 2002 (RR and (KL); February 15, 2002 (HHT)

COVER SHEET U.S. DEPARTMENT OF COMMERCE

Patent and Trademark Office
Atty Dkt No.: 01P14612 US

the attached original documents or copy thereof.

2. Name and address of receiving party(ies)

Name: Infineon Technologies North America Corp.

Street Address: 1730 North First Street

City: San Jose State: CA ZIP: 95112

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: February 8, 2002 (RR and (KL); February 15, 2002 (HHT)

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name Elsa Keller

Infineon Technologies North America Corp.
c/o Siemens Corporation

Intellectual Property Department

Street Address: 186 Wood Avenue South

City: Iselin State: NJ ZIP: 08830

6. Total number of applications and patents involved: 17. Total Fee (37 CFR 3.41) \$ 40.00☐ Enclosed☒ Authorized to be charged to deposit account

8. Deposit Account No.

19-2179

03/04/2002 DRYNE 00000121 192179 10077518

DO NOT USE THIS SPACE

9. Statement and signature

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Stanton C. Braden

Name of Person Signing

Reg. No.: 32,556

Signature

Date

Total number of pages including cover sheet, attachments, and document: _____

ASSIGNMENT

For good and valuable consideration, I, **Helmut H. Tews**, residing at Carl-Orff-Weg 1, Unterhaching, Germany, 82008 a citizen of German; **Ravikumar Ramachandran** residing at 199 Lake Shore Drive, Pleasantville, NY 10570, US, a citizen of India; **Kilho Lee**, residing at 324 Town View Drive, Wappingers Falls, NY 12590, US, a citizen of Korea;

hereby sell, assign, and transfer to Infineon Technologies North America Corp., a corporation organized and existing under the laws of the state of Delaware, having its principal place of business at, 1730 North First Street, San Jose, CA 95112;

hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewithin, and is entitled:

**Dual Gate Oxide Process Without Critical
Resist and Without N2 Implant**

and in and to said application and all divisional, continuing substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

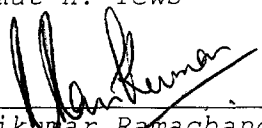
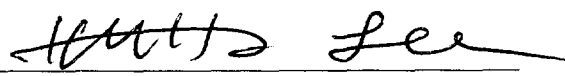
Agree that Assignee may apply for and receive Letters Patent for said improvements in its own name, and that, when requested, without charge to but at the expense of said Assignee, their successors, assigns, and legal representatives to carry out in good faith the intent and purpose of this agreement, the undersigned will execute all divisional, continuing substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns, or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents

-2-

on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date: _____

Helmut H. TewsDate: Feb 8, 2002_____

Ravikumar RamachandranDate: Feb. 8th, 2002_____

Kilho Lee

Attorney Docket No. 01P14612 US

ASSIGNMENT

For good and valuable consideration, I, **Helmut H. Tews**, residing at Carl-Orff-Weg 1, Unterhaching, Germany, 82008 a citizen of German; **Ravikumar Ramachandran** residing at 199 Lake Shore Drive, Pleasantville, NY 10570, US, a citizen of India; **Kil-Ho Lee**, residing at 324 Town View Drive, Wappingers Falls, NY 12590, US, a citizen of Korea;

hereby sell, assign, and transfer to Infineon Technologies North America Corp., a corporation organized and existing under the laws of the state of Delaware, having its principal place of business at, 1730 North First Street, San Jose, CA 95112;

hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewithin, and is entitled:

Dual Gate Oxide Process Without Critical Resist and Without N2 Implant

and in and to said application and all divisional, continuing substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that Assignee may apply for and receive Letters Patent for said improvements in its own name, and that, when requested, without charge to but at the expense of said Assignee, their successors, assigns, and legal representatives to carry out in good faith the intent and purpose of this agreement, the undersigned will execute all divisional, continuing substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns, or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents

Attorney Docket No. 01P14612 US

-2-

on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date: 2-15-2002

Helmut H. Tews
Helmut H. Tews

Date: _____

Ravikumar Ramachandran

Date: _____

Kil-Ho Lee